

# TrenchMOS™ transistor Logic level FET

BUK9514-30

## GENERAL DESCRIPTION

N-channel enhancement mode logic level field-effect power transistor in a plastic envelope using 'trench' technology. The device features very low on-state resistance and has integral zener diodes giving ESD protection up to 2kV. It is intended for use in automotive and general purpose switching applications.

## QUICK REFERENCE DATA

SYMBOL	PARAMETER	MAX.	UNIT
$V_{DS}$	Drain-source voltage	30	V
$I_D$	Drain current (DC)	69	A
$P_{tot}$	Total power dissipation	125	W
$T_j$	Junction temperature	175	°C
$R_{DS(ON)}$	Drain-source on-state resistance $V_{GS} = 5\text{ V}$	14	mΩ

## PINNING - TO220AB

PIN	DESCRIPTION
1	gate
2	drain
3	source
tab	drain

## PIN CONFIGURATION



## SYMBOL



## LIMITING VALUES

Limiting values in accordance with the Absolute Maximum System (IEC 134)

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
$V_{DS}$	Drain-source voltage	-	-	30	V
$V_{DGR}$	Drain-gate voltage	$R_{GS} = 20\text{ k}\Omega$	-	30	V
$\pm V_{GS}$	Gate-source voltage	-	-	10	V
$I_D$	Drain current (DC)	$T_{mb} = 25\text{ }^\circ\text{C}$	-	69	A
$I_D$	Drain current (DC)	$T_{mb} = 100\text{ }^\circ\text{C}$	-	48	A
$I_{DM}$	Drain current (pulse peak value)	$T_{mb} = 25\text{ }^\circ\text{C}$	-	240	A
$P_{tot}$	Total power dissipation	$T_{mb} = 25\text{ }^\circ\text{C}$	-	125	W
$T_{stg}, T_j$	Storage & operating temperature	-	- 55	175	°C

## THERMAL RESISTANCES

SYMBOL	PARAMETER	CONDITIONS	TYP.	MAX.	UNIT
$R_{th\ j-mb}$	Thermal resistance junction to mounting base	-	-	1.2	K/W
$R_{th\ j-a}$	Thermal resistance junction to ambient	in free air	60	-	K/W

## ESD LIMITING VALUE

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
$V_C$	Electrostatic discharge capacitor voltage	Human body model (100 pF, 1.5 kΩ)	-	2	kV

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### STATIC CHARACTERISTICS

T<sub>j</sub> = 25°C unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V <sub>(BR)DSS</sub>	Drain-source breakdown voltage	V <sub>GS</sub> = 0 V; I <sub>D</sub> = 0.25 mA; T <sub>j</sub> = -55°C	30 27	- -	- -	V V
V <sub>GS(TO)</sub>	Gate threshold voltage	V <sub>DS</sub> = V <sub>GS</sub> ; I <sub>D</sub> = 1 mA T <sub>j</sub> = 175°C T <sub>j</sub> = -55°C	1.0 0.5 -	1.5 - -	2.0 - 2.3	V V V
I <sub>DSS</sub>	Zero gate voltage drain current	V <sub>DS</sub> = 30 V; V <sub>GS</sub> = 0 V; T <sub>j</sub> = 175°C	-	0.05	10	μA
I <sub>GSS</sub>	Gate source leakage current	V <sub>GS</sub> = ±5 V; V <sub>DS</sub> = 0 V T <sub>j</sub> = 175°C	-	0.02	500	μA
±V <sub>(BR)GSS</sub>	Gate-source breakdown voltage	I <sub>G</sub> = ±1 mA; T <sub>j</sub> = 175°C	10	-	10	μA V
R <sub>DS(ON)</sub>	Drain-source on-state resistance	V <sub>GS</sub> = 5 V; I <sub>D</sub> = 25 A T <sub>j</sub> = 175°C	- -	12 -	14 26	mΩ mΩ

### DYNAMIC CHARACTERISTICS

T<sub>mb</sub> = 25°C unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
g <sub>fs</sub>	Forward transconductance	V <sub>DS</sub> = 25 V; I <sub>D</sub> = 25 A	12	25	-	S
Q <sub>g(tot)</sub>	Total gate charge	I <sub>D</sub> = 69 A; V <sub>DD</sub> = 24 V; V <sub>GS</sub> = 5 V	-	38	-	nC
Q <sub>gs</sub>	Gate-source charge		-	5	-	nC
Q <sub>gd</sub>	Gate-drain (Miller) charge		-	15	-	nC
C <sub>iss</sub>	Input capacitance	V <sub>GS</sub> = 0 V; V <sub>DS</sub> = 25 V; f = 1 MHz	-	2000	-	pF
C <sub>oss</sub>	Output capacitance		-	480	-	pF
C <sub>rss</sub>	Feedback capacitance		-	220	-	pF
t <sub>d on</sub>	Turn-on delay time	V <sub>DD</sub> = 15 V; I <sub>D</sub> = 25 A; V <sub>GS</sub> = 5 V; R <sub>G</sub> = 5 Ω	-	30	45	ns
t <sub>r</sub>	Turn-on rise time		-	80	130	ns
t <sub>d off</sub>	Turn-off delay time		-	100	140	ns
t <sub>f</sub>	Turn-off fall time		-	50	75	ns
L <sub>d</sub>	Internal drain inductance	Measured from contact screw on tab to centre of die	-	3.5	-	nH
L <sub>d</sub>	Internal drain inductance	Measured from drain lead 6 mm from package to centre of die	-	4.5	-	nH
L <sub>s</sub>	Internal source inductance	Measured from source lead 6 mm from package to source bond pad	-	7.5	-	nH

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**REVERSE DIODE LIMITING VALUES AND CHARACTERISTICS**
 $T_j = 25^\circ\text{C}$  unless otherwise specified

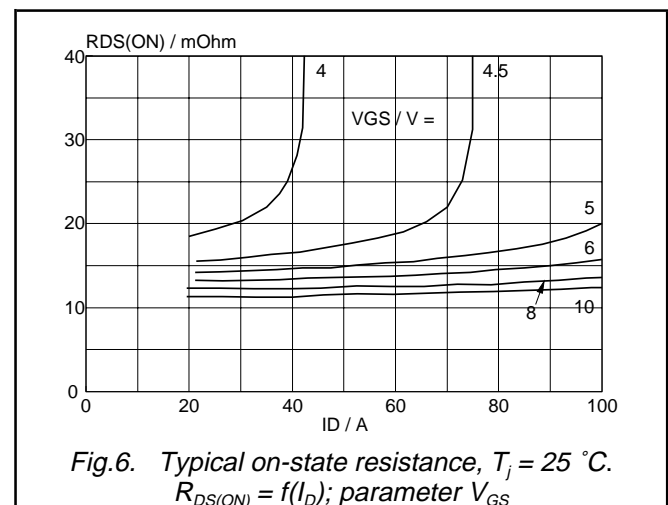
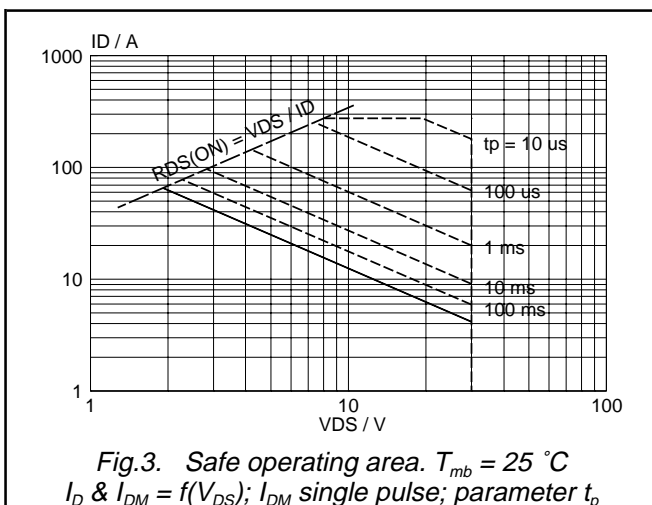
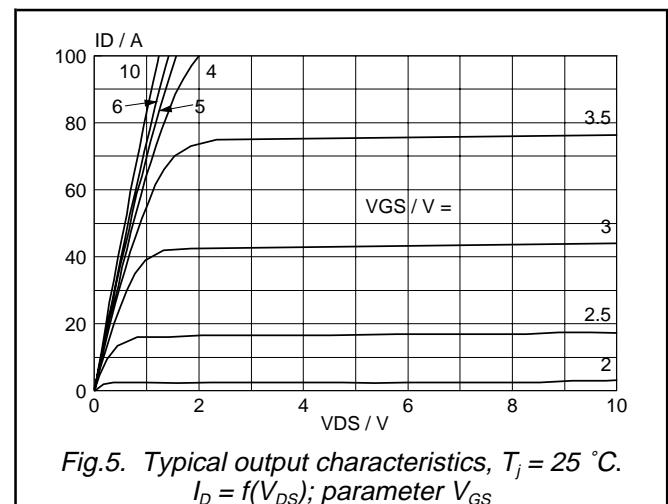
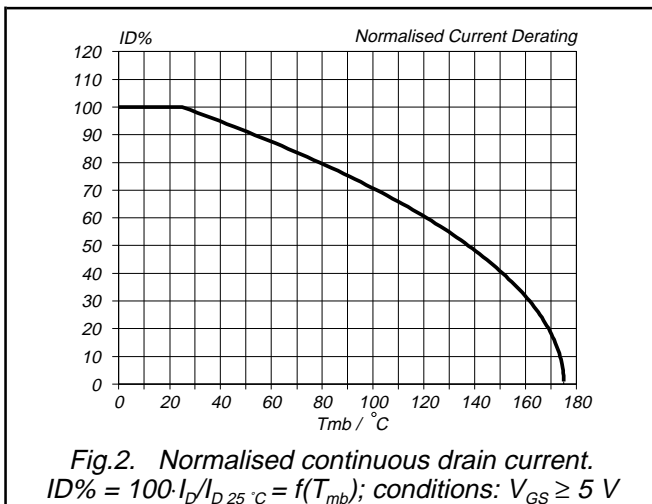
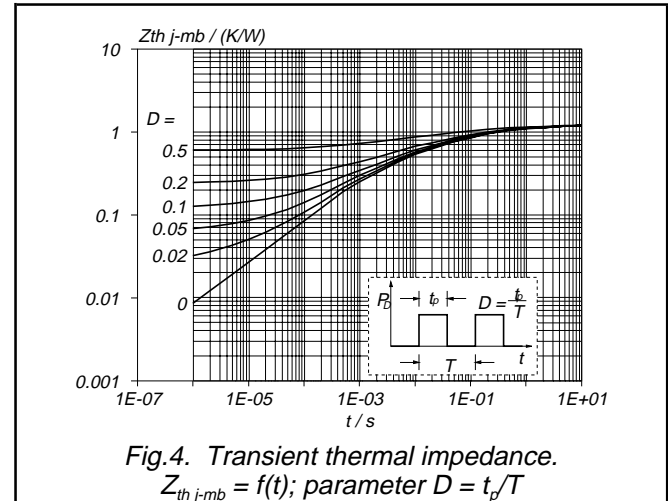
SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
$I_{DR}$	Continuous reverse drain current		-	-	69	A
$I_{DRM}$	Pulsed reverse drain current		-	-	240	A
$V_{SD}$	Diode forward voltage	$I_F = 25\text{ A}; V_{GS} = 0\text{ V}$	-	0.95	1.2	V
		$I_F = 69\text{ A}; V_{GS} = 0\text{ V}$	-	1.0	-	V
$t_{rr}$	Reverse recovery time	$I_F = 69\text{ A}; -di_F/dt = 100\text{ A}/\mu\text{s};$ $V_{GS} = -10\text{ V}; V_R = 25\text{ V}$	-	65	-	ns
$Q_{rr}$	Reverse recovery charge		-	0.1	-	$\mu\text{C}$

**AVALANCHE LIMITING VALUE**

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
$W_{DSS}$	Drain-source non-repetitive unclamped inductive turn-off energy	$I_D = 35\text{ A}; V_{DD} \leq 25\text{ V};$ $V_{GS} = 5\text{ V}; R_{GS} = 50\ \Omega; T_{mb} = 25^\circ\text{C}$	-	-	125	mJ

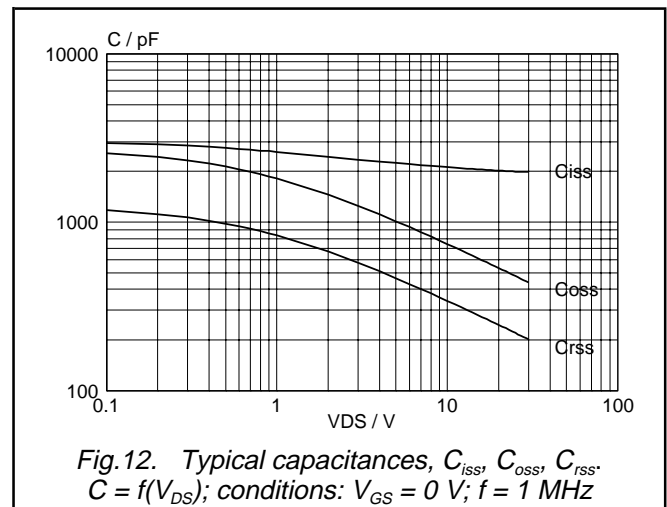
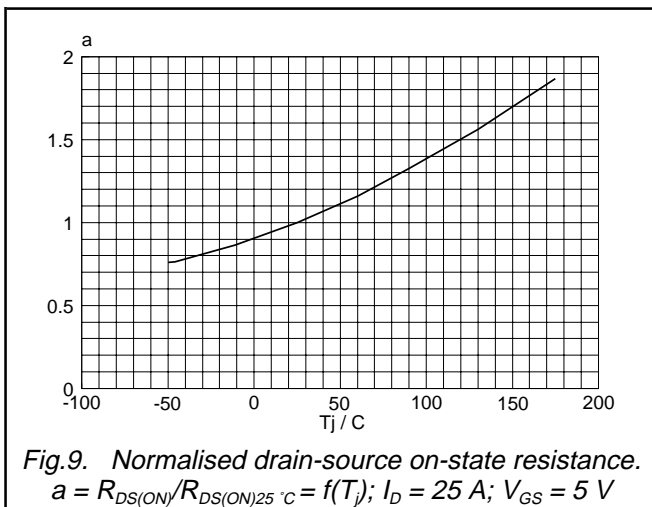
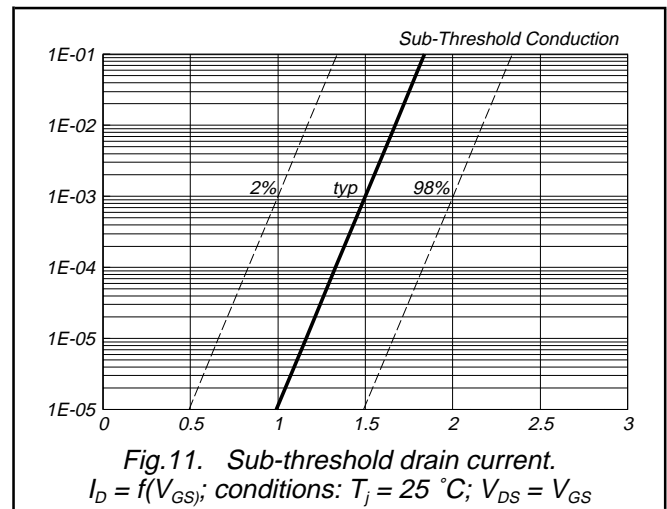
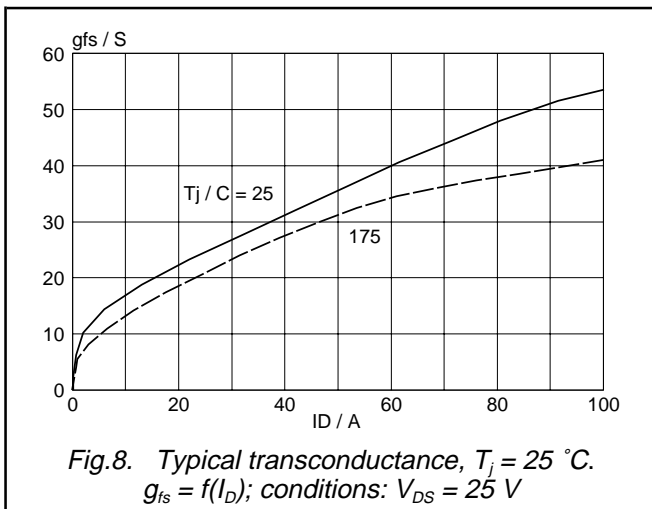
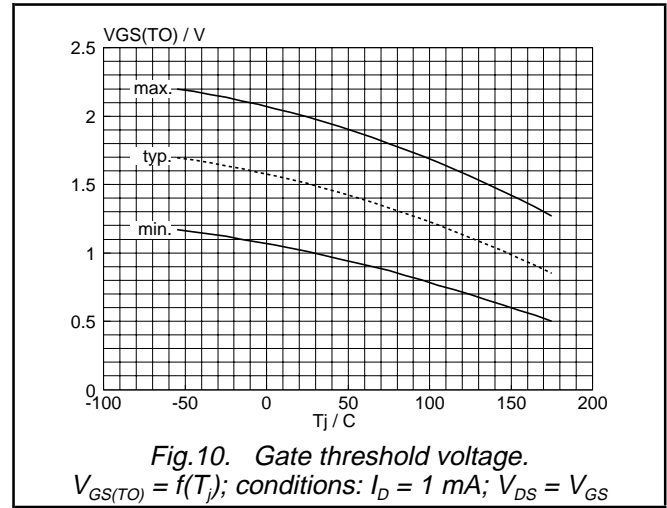
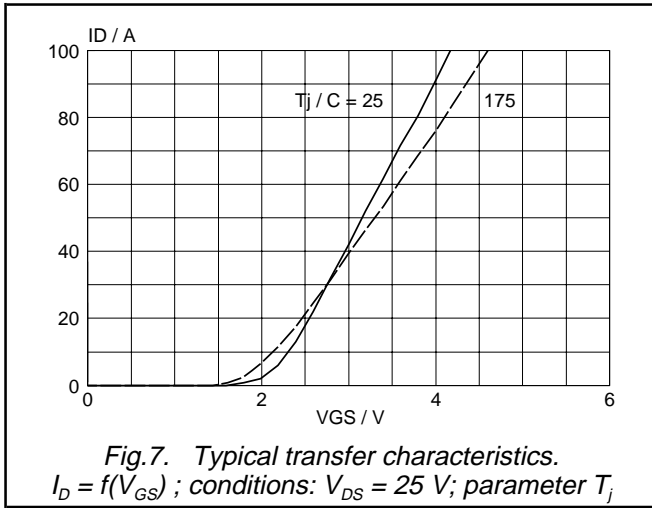
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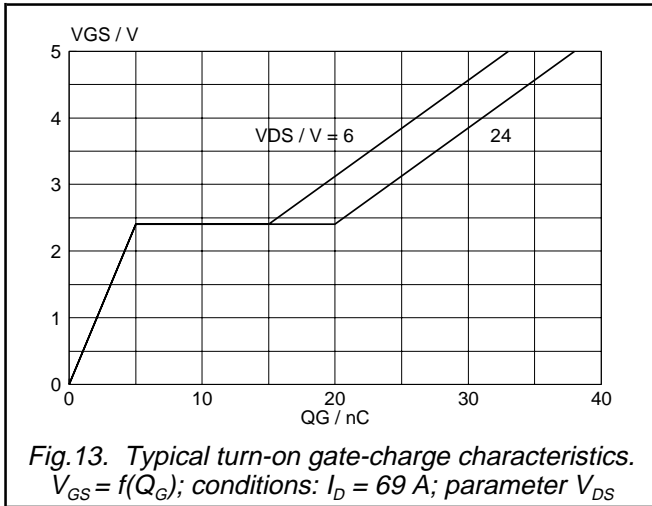


Fig. 13. Typical turn-on gate-charge characteristics.  $V_{GS} = f(Q_G)$ ; conditions:  $I_D = 69\text{ A}$ ; parameter  $V_{DS}$

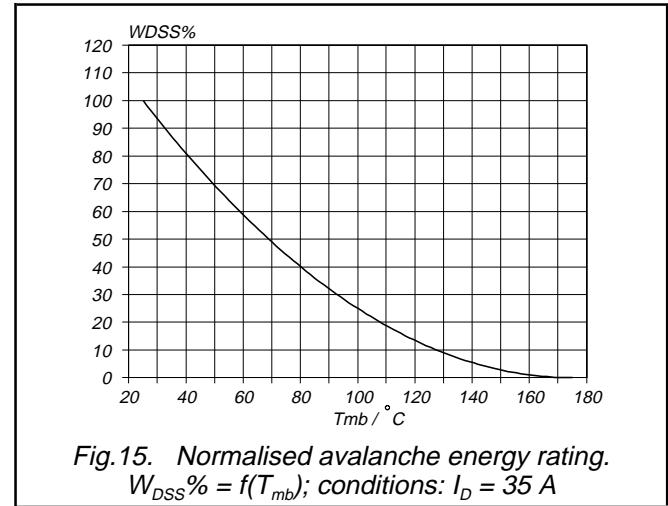


Fig. 15. Normalised avalanche energy rating.  $W_{DSS}\% = f(T_{mb})$ ; conditions:  $I_D = 35\text{ A}$

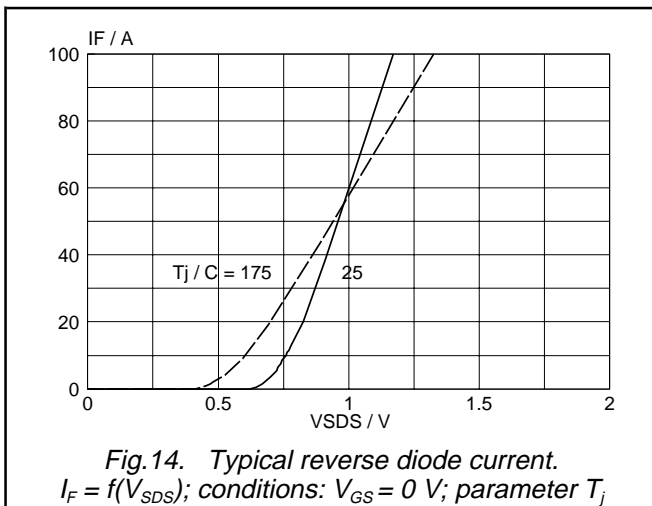


Fig. 14. Typical reverse diode current.  $I_F = f(V_{S_{DS}})$ ; conditions:  $V_{GS} = 0\text{ V}$ ; parameter  $T_j$



Fig. 16. Avalanche energy test circuit.  $W_{DSS} = 0.5 \cdot L I_D^2 \cdot BV_{DSS} / (BV_{DSS} - V_{DD})$



Fig. 17. Switching test circuit.

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**MECHANICAL DATA**



**Notes**

1. Observe the general handling precautions for electrostatic-discharge sensitive devices (ESDs) to prevent damage to MOS gate oxide.
2. Refer to mounting instructions for SOT78 (TO220) envelopes.
3. Epoxy meets UL94 V0 at 1/8".

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**DEFINITIONS**

<b>Data sheet status</b>	
Objective specification	This data sheet contains target or goal specifications for product development.
Preliminary specification	This data sheet contains preliminary data; supplementary data may be published later.
Product specification	This data sheet contains final product specifications.
<b>Limiting values</b>	
Limiting values are given in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of this specification is not implied. Exposure to limiting values for extended periods may affect device reliability.	
<b>Application information</b>	
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